



1. Material:

- Insulator: LCP, UL94V-0
- Contact: Copper Alloy
- Shell: SPCC
- Harpoon: Copper Alloy
- Rivet: Copper Alloy
- Screw: Brass.

2. Specification:

- Contact Current Rating: 1 Amperes.
- Dielectric Withstanding Voltage: AC 500V at sea level.
- Insulation Resistance: 1000 Megohms Min.
- Contact Resistance: 30 Milliohms Max.
- Operation Temperature: -55°C to +105°C.

<p>RoHS Compliant</p>		<p>HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.</p>	
<p>APPD. 核准 HELEN</p>	<p>SCALE 比例 参考</p>	<p>TOLERANCE 容許公差 .0 ±0.30 .00 ±0.20 ANG.±3°</p>	<p>PART NAME 品名 D-SUB R/A FOR NOTE BOOK-9F W/O SCREWS LAYOUT SINGLE ROW (24.99/15.9mm) MATERIAL:LCP ROHS</p>
<p>DWG. 製圖 ABBY</p>	<p>UNIT 單位 MM</p>	<p>SIZE. 紙張尺寸 A4</p>	<p>PART NO. 料號 C0526-09FBAXXXN</p>
<p>DATE 制表日 2018/05/09</p>	<p>PAGE 張數 1 OF 1</p>	<p>REV. 版次 A</p>	